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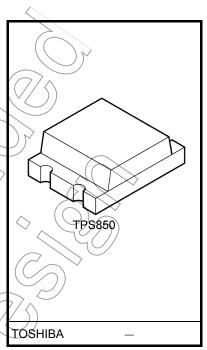
TOSHIBA Photo-IC Silicon Epitaxial Planar

TPS850

Mobile Phones, PHS
Notebook PCs, PDAs
Video Cameras, Digital Still Cameras
Other Equipment Requiring Luminosity Adjustment

The TPS850 is a linear-output photo-IC which incorporates a photodiode and a current amp circuit in a single chip. This photo-IC is current output type, so can set up output voltage freely by arbitrary load resistance.

- High sensitivity: I_L = 230 μA @EV = 100 lx (typ.) Using the fluorescent light
- Little fluctuation in light current
 Width range = x1 to x1.6 (typ. ±25%)
- Output linearity of illuminance is excellent
- Open-emitter output
- · Compact and light surface-mount package



Weight: 0.017 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage	((V _{CC}	–0.5 to 7	\\ v
Output voltage	VOUT	≦ V _{CC}	7/
Light current	// {\JL	10	mA
Permissible power dissipation	ƳP \	(70)	mW
Operating temperature range	→ T _{opr}	-30 to 85	°C
Storage temperature range	T _{stg}	-40 to 100	°C
Soldering temperature range (10 s) (Note 1)	T _{sol}	260	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: The reflow time and the recommended temperature profile are shown in the section entitled Handling Precautions.

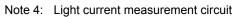
Electrical and Optical Characteristics (Ta = 25°C)

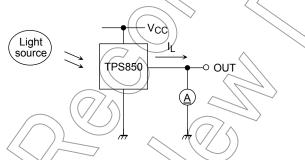
Chara	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Supply voltage		V _{CC}	_	2.7	_	5.5	V
Supply current		Icc	$V_{CC} = 3 \text{ V, } E_V = 1000 \text{ Ix,} $ $R_L = 250 \Omega$ (Note 2)	- <	4	_	mA
Light current (1)		I _L (1)	V _{CC} = 3 V, E _V = 100 lx (Note 2, 4)	_	300	_	
Light current (2)		I _L (2)	V _{CC} = 3 V, E _V = 10 lx (Note 3, 4)	18	23) ₃₀	μА
Light current (3)		I _L (3)	V _{CC} = 3 V, E _V = 100 lx (Note 3, 4)	180/	230	300	
Light current ratio		<u>IL (1)</u> IL (3)		7	1.3	1.7	
Dark current		I _{LEAK}	V _{CC} = 3.3 V, E _V = 0	>-	_	0.5	μА
Saturation output	voltage	Vo	$V_{CC} = 3 \text{ V}, R_L = 75 \text{ k}\Omega,$ $E_V = 100 \text{ lx}$ (Note 3)	2.2	2.35		, V
Peak sensitivity wa	avelength	λρ	_(())	\triangle	640		nm
Switching time	Rise time	t _r	V _{CC} = 3 V, R _L = 5 kΩ,	0.2	7(1//	ms	
	Fall time	t _f	(Note 5)	+0	0.35	2	1115

Note 2: CIE standard A light source is used (color temperature = 2856K, approximated incandescence light).

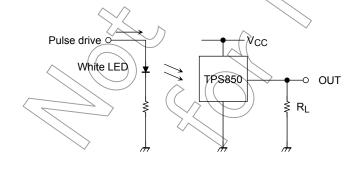
Note 3: Fluorescence light is used as light source. However, white LED is substituted in a mass-production process.

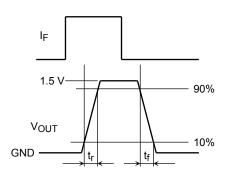
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Note 5: Rise time/fall time measurement method

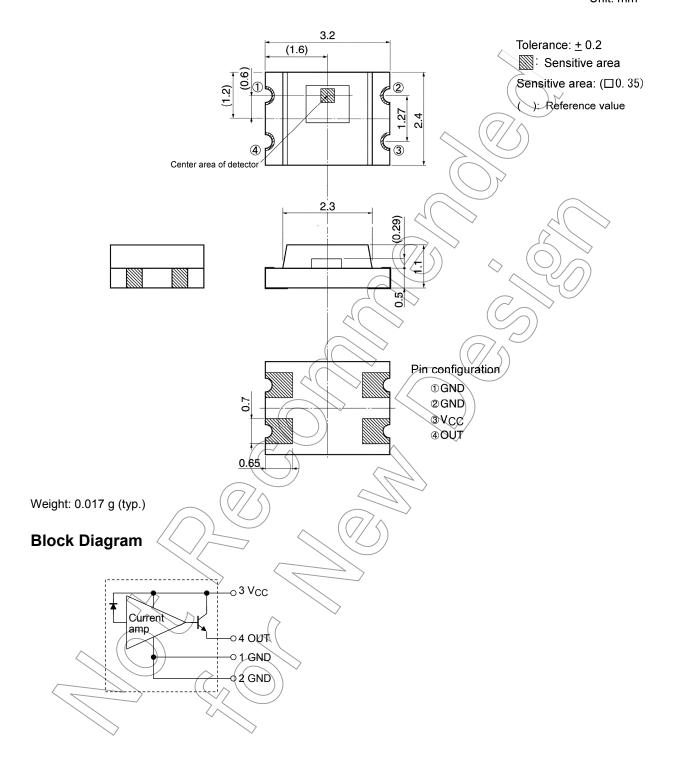






Package Dimensions

TPS850
Unit: mm



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Handling Precautions

At power on in darkness, the internal circuit takes about 50 ms to stabilize. During this period the output signal is unstable and may change. Please take this into account.

Moisture-Proof Packing

- (1) To avoid moisture absorption by the resin, the product is packed in an aluminum envelope with silica gel.
- (2) Since the optical characteristics of the device can be affected during soldering by vaporization resulting from prior absorption of moisture and they should therefore be stored under the following conditions:

Temperature: 5°C to 30°C, Relative humidity: 60% (max), Time: 168 h

(3) Baking is required if the devices have been store unopened for more than six months or if the aluminum envelope has been opened for more than 168 h.

These devices are packed on tapes; hence, please avoid baking at high temperature.

Recommended baking conditions: 60°C for 12 h or longer

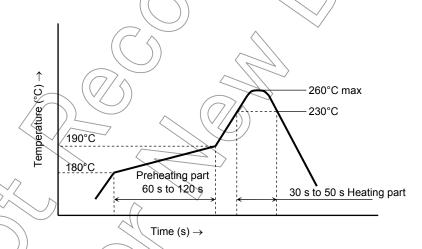
Mounting Precautions

- (1) Do not apply stress to the resin at high temperature.
- (2) The resin part is easily scratched, so avoid friction with hard materials.
- (3) When installing the assembly board in equipment, ensure that this product does not come into contact with other components.

Mounting Methods

- (1) Reflow soldering
 - Package surface temperature: 260°C (max)
 - Please perform reflow soldering using the following reference temperature profile.

 Perform reflow soldering no more than twice.



- Please perform the first reflow soldering within 168 h after opening the package with reference to the above temperature profile.
- Second reflow soldering

In case of second reflow soldering, it should be performed within 168 h after first reflow under the above conditions.

Storage conditions before second reflow soldering: 30°C, 60% RH or lower

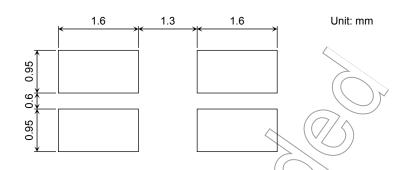
- Do not perform flow soldering.
- Make any necessary soldering correction manually.
 (do not do this more than once for any given pin.)

Temperature: no more than 350°C (25 W for soldering iron)

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Time: within 5 s

(2) Recommended soldering pattern



(3) Cleaning conditions

When cleaning is required after soldering

Chemicals: AK225 alcohol

Temperature and time: 50°C × 30 s or : 30°C × 3 minutes

Ultrasonic cleaning: 300 W or less

Packing Specification

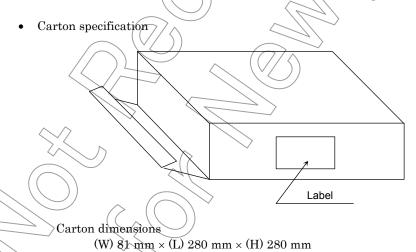
(1) Packing quantity



(2) Packing format

An aluminum envelope containing silica gel and reels is deaerated and sealed.

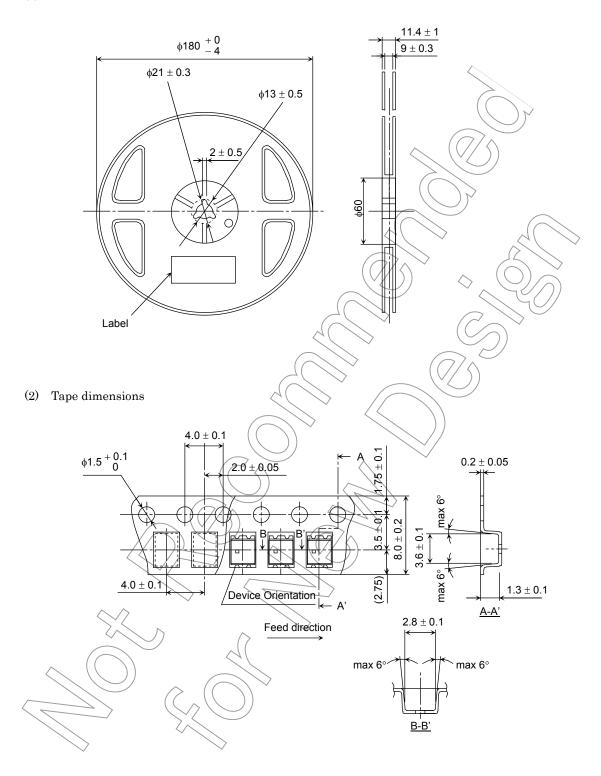
Pack shock-absorbent materials around the aluminum envelopes in the cartons to cushion them.



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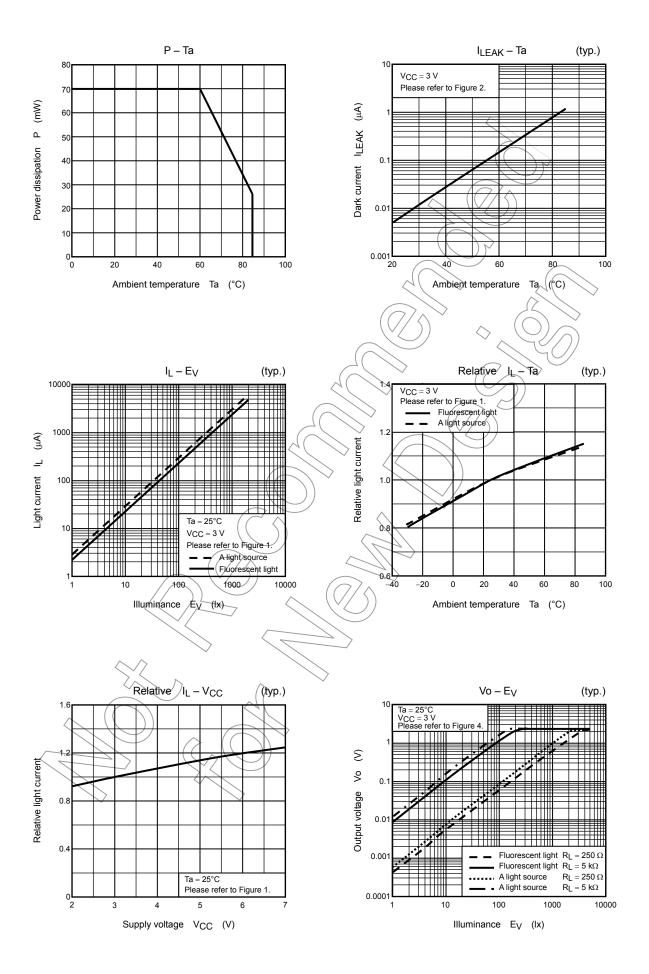
Tape Packing Specifications

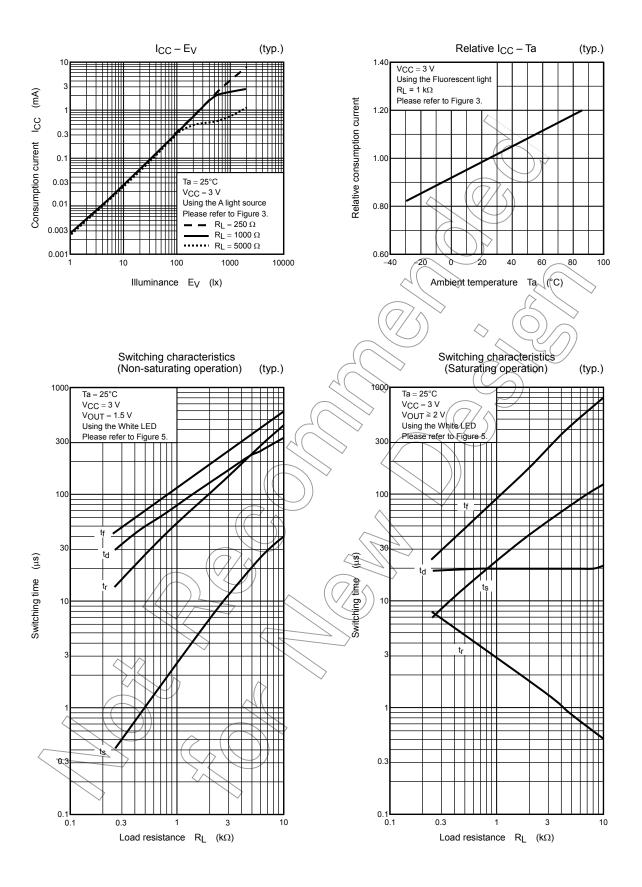
(1) Reel dimensions

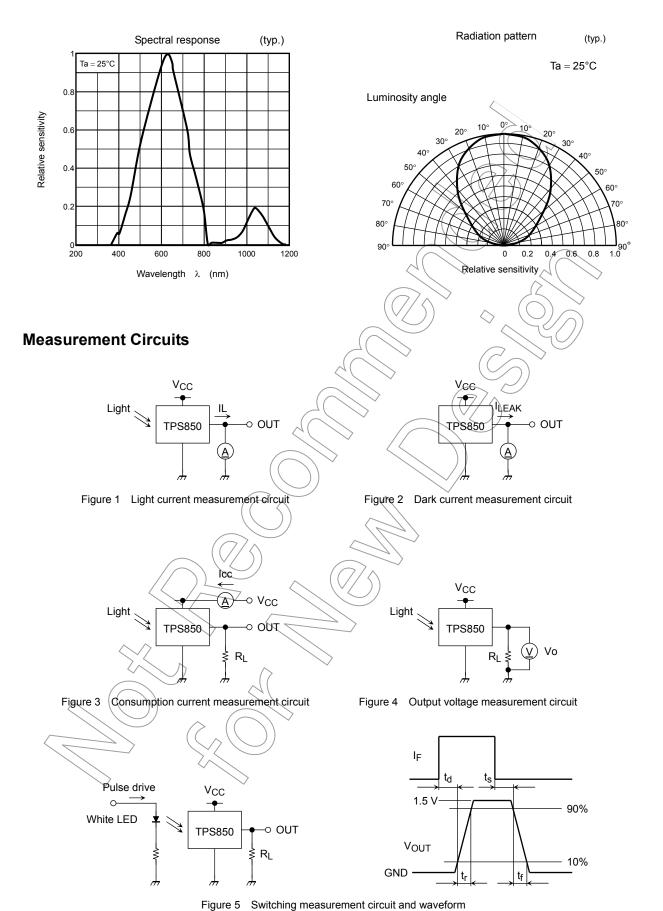


(3) Packing quantity: 3000/reel

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